ASECCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Par	PC. Bannockl	ourn. Illinois. A	ll rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	bstances v all lower	vithin the manufactu level materials for w	rer listed i which the r	tem. Note: nanufacture	if the item is an as r has engineering	sembly with low responsibility.	
	1.1 IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x Form Dist				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials a					ials and M	and Mfg Information			
upplier Information														
Company name* Compa			ompany unique ID			Unique ID Authority				Respon	Response Date*			
nsemi										2023-06-08				
ntact Name Title - Contact			ct			Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards Product Env			Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Authorized Representative* Title - Repr			epresentative			Phone - Representative*				Email - Representative*				
Product-Env-Stewards Produc			roduct Enviro Compliance			NA				Product-Env-Stewards@onsemi.com				
Requester Item Number	Mfr Iten	n Number	Mfr Item Name			Effective Date	e Version Manufacturing Site			Weight*	UOM	Unit Type		
	FSA115	FSA1156P6X SPST Ana		Analog Switch		2023-06-08		PI	PBB		5.959	mg	Each	
Ianufacturing Proccess Informa	tion							·						
Terminal Plating / Grid Array M	aterial 7	Ferminal Base A	Alloy J-STD-020 MSL Ra		L Rating	Peak Proce	Process Body Temperatu		ure Max Time at Peak Tempe		ure Num	ber of Reflow Cyc	les	
Matte Tin (Sn) - annealed CU Alloy		CU Alloy		1		260		С	30	secor	ids 3			
omments														
vel 1 - maximum time at peak temperatu	ire during so	ldering is 10-3	0 seconds											
or more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	IS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead , Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl alate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.148	mg	Supplier	Silicon (Si)	7440-21-3		0.148	mg
Die Attach Epoxy	0.037	mg	Supplier	Silver (Ag)	7440-22-4		0.034	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.003	mg
Lead Frame	2.25	mg	Supplier	Silver (Ag)	7440-22-4		0.022	mg
			Supplier	Zinc (Zn)	7440-66-6		0.003	mg
			Supplier	Iron (Fe)	7439-89-6		0.054	mg
			Supplier	Copper (Cu)	7440-50-8		2.17	mg
			Supplier	Phosphorus (P)	7723-14-0		0.001	mg
Mold Compound-Black	3.224	mg	Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.935	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0322	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2.2568	mg
Plating	0.274	mg	Supplier	Tin (Sn)	7440-31-5		0.274	mg
Wire Bond - Au	0.026	mg	Supplier	Gold (Au)	7440-57-5		0.026	mg